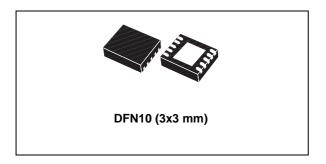


### Electronic fuse for 12 V line

Datasheet - production data



### **Features**

- Continuous current (typ): 3.6 A
- N-channel on-resistance (typ): 53 mΩ
- Enable/Fault functions
- Output clamp voltage (typ):15 V
- Undervoltage lockout
- Short-circuit limit
- Overload current limit
- Controlled output voltage ramp
- Thermal latch (typ): 165 °C
- · Uses tiny capacitors
- Operating junction temp. 40 °C to 125 °C
- Available in DFN10 (3x3 mm) package

### **Applications**

- Hard disk drives
- Solid state drives (SSD)
- Hard disk and SSD arrays
- Set-top boxes
- DVD and Blu-ray disc drivers

### **Description**

The STEF12 is an integrated electronic fuse optimized for monitoring output current and input voltage. Connected in series to a 12 V rail, it is capable of protecting the electronic circuitry on its output from overcurrent and overvoltage. The device has a controlled delay and turn-on time. When an overload condition occurs, the STEF12 limits the output current to a predefined safe value. If the anomalous overload condition persists it goes into an open state, disconnecting the load from the power supply. If a continuous short-circuit is present on the board, when power is re-applied the E-fuse initially limits the output current to a safe value and then again goes into an open state. The device is equipped with a thermal protection circuit. The intervention of the thermal protection is signalled to the board monitoring circuits through a signal on the Fault pin. Unlike the mechanical fuses, which must be physically replaced after a single event, the Efuse does not degrade in its performance after short-circuit/thermal protection interventions and it is reset either by recycling the supply voltage or using the Enable pin. The companion chip for the 5 V power rails is also available with part number STEF05.

Table 1. Device summary

Order code	Package	Packing
STEF12PUR	DFN10 (3x3 mm)	Tape and reel

Contents STEF12

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## 1 Device block diagram

Vcc ENABLE OF CHARGE **ENABLE OSCILLATOR** PUMP POWER SENSE dV/dT CURRENT **VOLTAGE** dV/dT o-CONTROL CONTROL CONTROL **THERMAL** UVLO GND PROTECTION AM09891v1 
 J-LIMIT
 Vout o

Figure 1. STEF12 block diagram

Pin configuration STEF12

## 2 Pin configuration

Figure 2. Pin configuration (top view)

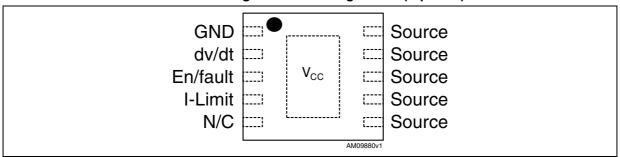


Table 2. Pin description

Pin n°	Symbol	Note
1	GND	Ground pin
2	dv/dt	The internal dv/dt circuit controls the slew rate of the output voltage at turn-on. The internal capacitor allows a ramp-up time of around 1ms. An external capacitor can be added to this pin to increase the ramp time. If an additional capacitor is not required, this pin should be left open.
3	En/Fault	The Enable/Fault pin is a tri-state, bi-directional interface. During normal operation the pin must be left floating, or it can be used to disable the output of the device by pulling it to ground using an open drain or open collector device.  If a thermal fault occurs, the voltage on this pin goes into an intermediate state to signal a monitor circuit that the device is in thermal shutdown. It can be connected to another device of this family to cause a simultaneous shutdown during thermal events.
4	I-Limit	A resistor between this pin and the Source pin sets the overload and short-circuit current limit levels.
5	NC	Not connected
6 to 10	V <sub>OUT</sub> /Source	Connected to the source of the internal power MOSFET and to the output terminal of the fuse
11	V <sub>CC</sub>	Exposed pad. Positive input voltage must be connected to V <sub>CC</sub> .

STEF12 Maximum ratings

## 3 Maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
	Positive power supply voltage (steady state)	-0.3 to 18	V
V <sub>CC</sub>	Positive power supply voltage (max 100ms)	-0.3 to 25	V
V <sub>OUT</sub> /source	(max 100ms)	-0.3 to Vcc+0.3	V
I-Limit	(max 100ms)	-0.3 to 25	V
En/Fault		-0.3 to 7	V
dv/dt		-0.3 to 7	V
T <sub>op</sub>	Operating junction temperature range (1)	-40 to 125	°C
T <sub>STG</sub>	Storage temperature range	-65 to 150	°C
T <sub>LEAD</sub>	Lead temperature (soldering) 10 sec	260	°C

<sup>1.</sup> The thermal limit is set above the maximum thermal rating. It is not recommended to operate the device at temperatures greater than the maximum ratings for extended periods of time.

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

Table 4. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJA</sub>	Thermal resistance junction-ambient	52.7	°C/W
R <sub>thJC</sub>	Thermal resistance junction-case	17.4	°C/W

Table 5. ESD performance

Symbol	Parameter	Test conditions	Value	Unit
	ESD protection	НВМ	2	kV
ESD		MM	200	V
		CDM	500	V

Electrical characteristics STEF12

## 4 Electrical characteristics

 $V_{CC}$  = 12 V,  $V_{EN}$  = 3.3 V,  $C_I$  = 10  $\mu F,\,C_O$  = 47  $\mu F,\,T_J$  = 25 °C (unless otherwise specified).

**Table 6. Electrical characteristics for STEF12** 

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Under/Ove	ervoltage protection				•	
V <sub>Clamp</sub>	Output clamping voltage	V <sub>CC</sub> = 18 V	13.8	15	16.2	V
V <sub>UVLO</sub>	Undervoltage lockout	Turn-on, voltage rising	7.7	8.5	9.3	V
V <sub>Hyst</sub>	UVLO hysteresis			0.80		V
Power MO	SFET			•	•	
t <sub>dly</sub>	Delay time	Enabling of chip to I <sub>D</sub> = 100 mA with a 1 A resistive load		350		μs
В.	On-resistance	(1)	35	53	70	mΩ
$R_{DSon}$	On-resistance	- 40 °C < T <sub>J</sub> < 125 °C <sup>(2)</sup>			82	11152
V <sub>OFF</sub>	Off state output voltage	$V_{CC}$ = 18 V, $V_{GS}$ = 0, $R_L$ = infinite		40	100	mV
		0.5in <sup>2</sup> pad, T <sub>A</sub> = 25 °C <sup>(1)</sup>		3.6		^
I <sub>D</sub>	Continuous current	Minimum copper, T <sub>A</sub> = 80 °C		1.7		A
Current lin	nit					
I <sub>Short</sub>	Short-circuit current limit	R <sub>Limit</sub> = 22 Ω	3.3	4.4	5.5	А
I <sub>Lim</sub>	Overload current limit	R <sub>Limit</sub> = 22 Ω		4.4		Α
dv/dt circu	iit					
dv/dt	Output voltage ramp time	Enable to V <sub>OUT</sub> = 11.7 V, No C <sub>dv/dt</sub>	0.5	0.9	2.6	ms
Enable/Fa	ult					
V <sub>IL</sub>	Low level input voltage	Output disabled	0.35	0.58	0.81	V
V <sub>I(INT)</sub>	Intermediate level input voltage	Thermal fault, output disabled	0.82	1.4	1.95	V
V <sub>IH</sub>	High level input voltage	Output enabled	1.96	2.64	3.3	V
V <sub>I(MAX)</sub>	High state maximum voltage		3.4	4.3	5.4	V
I <sub>IL</sub>	Low level input current (sink)	V <sub>Enable</sub> = 0 V		-10	-30	μΑ
l <sub>l</sub>	High level leakage current for external switch	V <sub>Enable</sub> = 3.3 V			1	μA
	Maximum fan-out for fault signal	Total numbers of chips that can be connected to this pin for simultaneous shutdown			3	Units



Table 6. Electrical characteristics for STEF12 (continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Total devic	Total device					
I <sub>Bias</sub>	Bias current	Device operational		1.5	2	mA
		Thermal shutdown		1		
V <sub>min</sub>	Minimum operating voltage				7.6	V
Thermal la	Thermal latch					
TSD	Shutdown temperature	(1)		165		°C

<sup>1.</sup> Pulse test: Pulse width = 300  $\mu$ s, Duty cycle = 2%

<sup>2.</sup> Guaranteed by design, but not tested in production

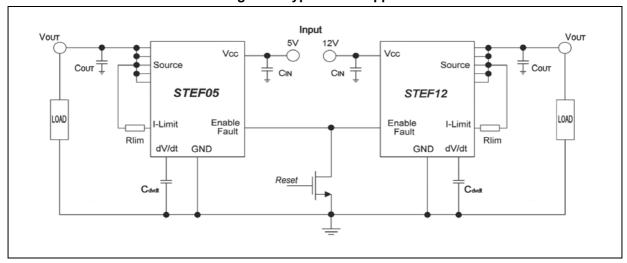
**Typical application** STEF12

#### **Typical application** 5

 $V_{\text{CC}}$ V<sub>OUT</sub>/Source EN/Fault  $\mathsf{C}^{^{\mathsf{I}\!\mathsf{N}}}$ LOAD R-lim  $C_{\text{OUT}}$ Controller I-limit dV/dT STEF12 GND AM09881v1

Figure 3. Application circuit

Figure 4. Typical HDD application circuit



#### **Operating modes** 5.1

#### 5.1.1 Turn-on

When the input voltage is applied, the Enable/Fault pin goes up to the high state, enabling the internal control circuitry.

After an initial delay time of typically 350 µs, the output voltage is supplied with a slope defined by the internal dv/dt circuitry. If no additional capacitor is connected to dv/dt pin, the total time from the Enable signal going high and the output voltage reaching the nominal value is around 1 ms (refer to Figure 5, 15)

STEF12 Typical application

### 5.1.2 Normal operating condition

The STEF12 E-fuse behaves like a mechanical fuse, buffering the circuitry on its output with the same voltage shown at its input, with a small voltage fall due to the N-channel MOSFET  $R_{DSOn}$ .

### 5.1.3 Output voltage clamp

This internal protection circuit clamps the output voltage to a maximum safe value, typically 15 V, if the input voltage exceeds this threshold.

### 5.1.4 Current limiting

When an overload event occurs, the current limiting circuit reduces the conductivity of the power MOSFET, in order to clamp the output current at the value selected externally by means of the limiting resistor R<sub>l imit</sub> (*Figure 3*).

#### 5.1.5 Thermal shutdown

If the device temperature exceeds the thermal latch threshold, typically 165 °C, the thermal shutdown circuitry turns the power MOSFET off, thus disconnecting the load. The EN/Fault pin of the device is automatically set at an intermediate voltage, in order to signal the overtemperature event. In this condition the E-fuse can be reset either by cycling the supply voltage or by pulling down the EN pin below the  $V_{il}$  threshold and then releasing it.

### 5.2 R limit calculation

As shown in *Figure 3*, the device uses an internal N-channel sense FET with a fixed ratio, to monitor the output current and limit it at the level set by the user.

The R<sub>Limit</sub> value for achieving the requested current limitation can be estimated by using the following theoretical formula, together with the graph in *Figure 13: Current limit vs. RLimit*.

#### **Equation 1**

RLimit = 
$$\frac{95}{I \text{Short}}$$

### $C_{dy/dt}$ calculation

Connecting a capacitor between the  $C_{dv/dt}$  pin and GND allows the modification of the output voltage ramp-up time.

Given the desired time interval  $\Delta t$  during which the output voltage goes from zero to its maximum value, the capacitance to be added on the  $C_{dv/dt}$  pin can be calculated using the following theoretical formula:

#### **Equation 2**

$$C_{dv/dt} = 3.92 \times 10^{-8} \Delta t - 35.3 \times 10^{-12}$$

Where  $C_{dv/dt}$  is expressed in Farads and the time in seconds.

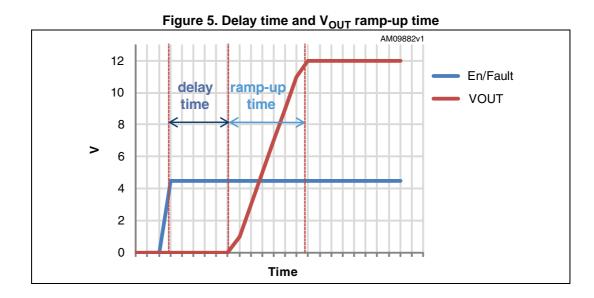
Typical application STEF12

The addition of an external  $C_{dv/dt}$  influences also the initial delay time, defined as the time between the Enable signal going high and the start of the  $V_{OUT}$  slope (*Figure 5*).

The contribution of the external capacitor to this time interval can be estimated by using the following theoretical formula:

#### **Equation 3**

delay time [s] = 
$$35 \times 10^{-5} + 71 \times 10^{5} \times C_{dvdt}$$
 [F



### 5.4 Enable/Fault pin

The Enable/Fault pin has the dual function of controlling the output of the device and, at the same time, of providing information about the device status to the application.

When it is used as a standard Enable pin, it should be connected to an external open-drain or open-collector device. In this case, when it is pulled at low logic level, it turns the output of the E-Fuse off.

If this pin is left floating, since it has internal pull-up circuitry, the output of the E-Fuse is kept ON, in normal operating conditions.

In case of thermal fault, the pin is pulled to an intermediate state (*Figure 6*). This signal can be provided to a monitor circuit, informing it that a thermal shutdown has occurred, or it can be directly connected to the Enable/Fault pins of other STEFxx devices on the same application in order to achieve a simultaneous enable/disable feature.

When a thermal fault occurs, the device can be reset either by cycling the supply voltage or by pulling down the Enable pin below the V<sub>il</sub> threshold and then releasing it.

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STEF12 Typical application

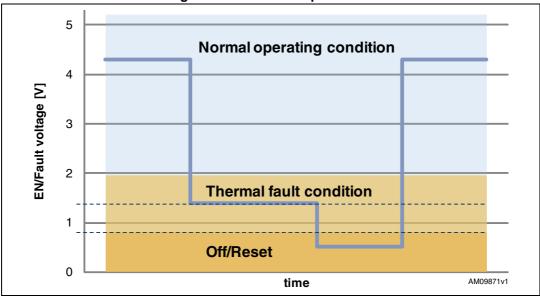
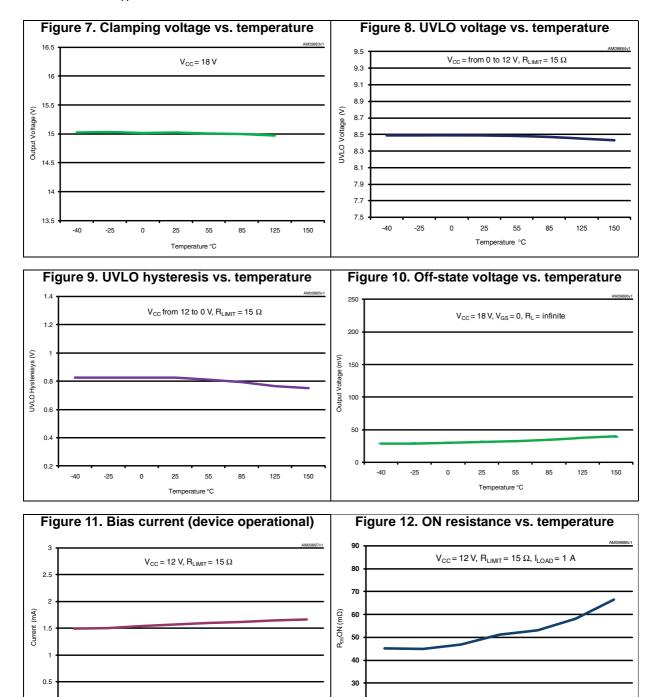


Figure 6. Enable/Fault pin status

## **6** Typical performance characteristics

The following plots are referred to the typical application circuit and, unless otherwise noted, at  $T_A = 25 \, ^{\circ}\text{C}$ .

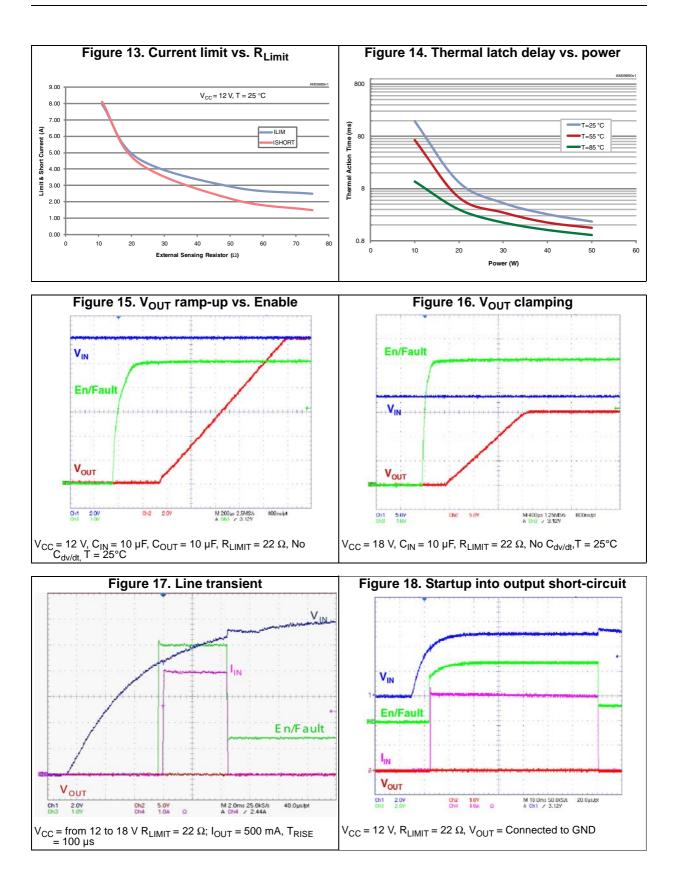


Temperature °C

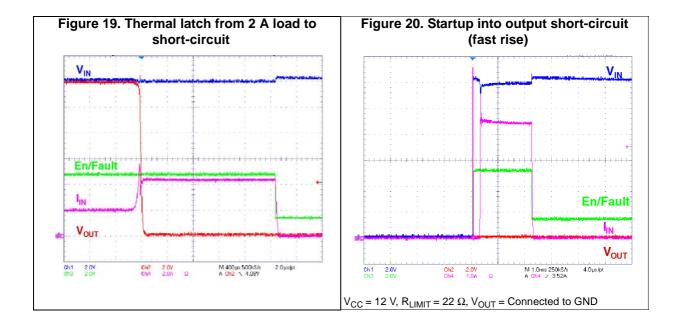
55

Temperature °C

125







57

STEF12 Package information

## 7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.



Package information STEF12

#### 7.1 DFN10L (3x3 mm) package information

SEATING PLANE С A3 D е PIN1 ID (Opt.A) E2 ш 9 10 8 b PIN1 ID D2 (Opt.B)\_ BOTTOM VIEW

Figure 21. DFN10L package outline

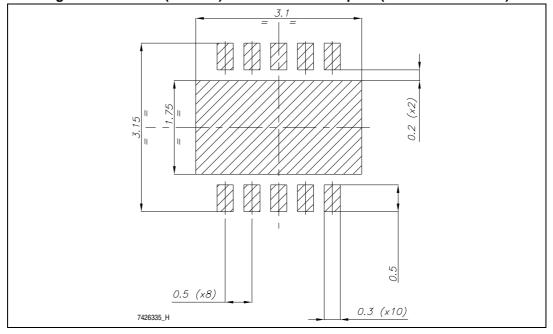
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STEF12 Package information

Table 7. DFN10L (3x3 mm.) mechanical data

Dim.		mm.	
Dilli.	Min.	Тур.	Max.
А	0.80	0.90	1.00
A1		0.02	0.05
A2	0.55	0.65	0.80
А3		0.20	
b	0.18	0.25	0.30
D	2.85	3.00	3.15
D2	2.20		2.70
E	2.85	3.00	3.15
E2	1.40		1.75
E3		0.230	
E4		0.365	
е		0.50	
L	0.30	0.40	0.50
ddd			0.08

Figure 22. DFN10L (3x3 mm) recommended footprint (dimensions in mm.)



Package information STEF12

## 7.2 DFNxx (3x3 mm) packing information

A Po Note: Drawing not in scale

Figure 23. DFNxx (3x3 mm) tape and reel outline

Table 8. DFNxx (3x3 mm) tape and reel mechanical data

Dim.		mm.	
	Min.	Тур.	Max.
Α			330
С	12.8		13.2
D	20.2		
N	60		
Т			18.4
Ao		3.3	
Во		3.3	
Ko		1.1	
Ро		4	
Р		8	

STEF12 Revision history

# 8 Revision history

Table 9. Document revision history

Date	Revision	Changes
15-Jul-2011	1	Initial release.
08-Aug-2011	2	Modified definition for T <sub>op</sub> in <i>Table 3: Absolute maximum ratings</i> .
14-Dec-2011	3	Removed V <sub>dv/dt</sub> and I <sub>dv/dt</sub> rows from dv/dt circuit <i>Table 6 on page 6</i> .
06-Mar-2012	4	Updated: package mechanical data <i>Table 7 on page 17</i> , <i>Figure 21 on page 16</i> and <i>Figure 24 on page 19</i> .
14-Jan-2013	5	Updated: package mechanical data <i>Table 7 on page 17</i> and <i>Figure 21 on page 16</i> .
03-Aug-2015	6	Updated Equation 2, Equation 3 and Section 7: Package information.  Minor text changes.

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